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Form <b>PTO-1595</b> (Rev. 10/02) OMB No. 0651-0027 (exp. 6/30/2005)	1027447		r		nt and Tradema	
Tab settings ⇔ ⇔ ♥ To the Honorable Commissioner o				viginal de surresta e	· · · · ·	
1. Name of conveying party(ies): Masaya UCHIDA	5.7.04	2. Name a	nd address	of receiving pa	irty(ies)	PT0
Kanji NAKAO Yoshiyuki YOKOTA		Internal	Address: 1	-1, Koraibash		8403
Additional name(s) of conveying party(ies) a	ittached? Yes 🖌 No	Chuo	-ku, Osaka	a-shi		22 <sup>387</sup> 10/84
3. Nature of conveyance:		Osaka	541-0043	JAPAN		23.
Assignment     Security Agreement	Merger Change of Name	Street A	.ddress:		·	
Other04-26-2004				State:		
04-26-2004 Execution Date:		Additional	name(s) & ad	dress(es) attached	? 🗌 Yes 🔽	No
<ol> <li>Application number(s) or patent r</li> <li>If this document is being filed tog</li> <li>A. Patent Application No.(s)</li> </ol>	ether with a new appli	B. Pater		te of the applica		
5. Name and address of party to wh concerning document should be r Name: <u>Roylance</u> , Abrams, Berdo & Internal Address:	nailed: Goodman, L.L.P.		(37 CFR 3	lications and pa 41)\$		Length
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Street Address:1300 19th Stree Suite 600	et, N.W.	8. Deposit a	account nur	nber:		
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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## **ASSIGNMENT**

WHEREAS, We, (1) <u>Masaya UCHIDA</u>, (2) <u>Kanji NAKAO</u>, and (3) <u>Yoshiyuki YOKOTA</u>, all citizens of <u>JAPAN</u>, residing respectively at (1) <u>Osaka-shi, OSAKA JAPAN</u>, (2) <u>Suita-shi, OSAKA JAPAN</u>, and (3) <u>Suita-shi, OSAKA JAPAN</u>, (hereinafter ASSIGNORS), have made a certain invention entitled <u>AQUEOUS RESIN COMPOSITION AND ITS USES</u> for which we are making application for Letters Patent of the United States, which application has been executed concurrently herewith; and

WHEREAS, Nippon Shokubai Co., Ltd. , a corporation duly organized under the laws of <u>JAPAN</u>, located and doing business at <u>1-1, Koraibashi 4-chome, Chuo-ku, Osaka-shi, Osaka</u> <u>541-0043 JAPAN</u> (hereinafter ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all Letters Patent to be obtained on said invention and/or application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to us by said ASSIGNEE the receipt and sufficiency of which is hereby acknowledged, we, the ASSIGNORS and, by these presents do hereby sell, assign, set over and transfer unto the said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States and all countries foreign thereto; and in, to and under the aforesaid United States application and any corresponding foreign applications and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in any country; and our right to file said foreign applications and claim priority under the provisions of the International Convention; and any Letters Patent of the United States or any foreign country issued or granted on said invention and/or said applications;

AND WE HEREBY authorize and request the Patent Office or other issuing authority to issue any and all patents on said invention and/or said application to said ASSIGNEE as sole assignee; and we further hereby authorize said ASSIGNEE to file and prosecute any of said foreign applications in its own name;

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AND WE HEREBY covenant that we have the full right to convey the entire right, title and interest herein assigned and that we have not executed and will not execute any assignment or other instrument in conflict herewith;

AND WE HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable compensation; and generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in all countries, and likewise we make these provisions binding upon our heirs, legal representatives and/or administrators.

IN WITNESS WHEREOF, we have hereunder set our hand and seal.

Apirl 26, 2004	M. Chil	
Date	Name: Masaya UCHIDA	
April 26, 2004	Id. Nakac	
Date	Name: Kanji NAKAO	
April 26, 2004	Moshiyuki Yokota Name: Yoshiyuki YOKOTA	
Date	Name: Yoshiyuki YOKOTA	